







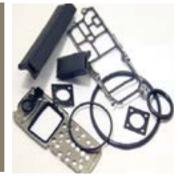
aerospace climate control electromechanical filtration fluid & gas handling hydraulics pneumatics process control sealing & shielding







Conductive Elastomer EMI Gaskets Molded and Extruded Materials Selection Guide





ENGINEERING YOUR SUCCESS.

EMI Materials

INTRODUCTION

CONDUCTIVE ELASTOMER SELECTION GUIDE

Tables 5a and 5b contained herein provide selection guidelines for Chomerics' most general-purpose EMI elastomer materials. With the exception of certain limitations noted under "Remarks", these materials are electrically stable over time and provide excellent moisture and pressure sealing. They are all medium-durometer materials and differ mainly in shielding performance and corrosion resistance. (Nickel-plated aluminum materials are significantly more corrosion-resistant than silver-plated copper, silverplated aluminum, and silver-plated nickel filled materials against aluminum.)

- Availability
- Design Flexibility
- Cost Effectiveness
- Proven Performance

...just four of the reasons why conductive elastomer gaskets are so often the right EMI shielding solution!

Once used mainly to shield critical defense and aerospace electronic systems, Parker Chomerics conductive elastomers have become the progressive choice for packaging designers of consumer, telecommunications, business, industrial equipment, automotive, medical devices and much more.

Conductive elastomers are reliable over the life of the equipment. The same gasket is both an EMI shield and an environmental seal. Elastomer gaskets resist compression set, accommodate low closure force, and help control airflow. They're available in corrosion-resistant and flameresistant grades. Their aesthetic advantages are obvious.

Almost any elastomer profile can be extruded or custommolded with modest tooling costs and short lead times for either prototypes or large orders. Parker Chomerics can also take a customer-supplied design and deliver finished parts. Parker Chomerics offers hundreds of standard molded and extruded products. Molded products provide moisture/pressure sealing and EMI/EMP shielding when compressed properly in seals, flanges, bulkheads, and other assemblies. Extrusions provide similar benefits and are also readily lathe-cut into washers, spliced, bonded, kiss-cut, or die-cut to reduce installation labor and to conserve material, resulting in a cost-effective alternative to other methods of EMI shielding and environmental sealing.

CHO-SEAL® CONDUCTIVE ELASTOMERS

Over the years, Parker Chomerics has developed and enhanced virtually every aspect of conductive elastomer materials technology, from the earliest silver and silver-plated copper filled silicones, to the latest and more cost-effective nickel-plated aluminum and nickel-plated graphite composites. Today we offer the most comprehensive selection and highest quality products available.

Each conductive elastomer consists of a silicone, fluorosilicone, EPDM or fluorocarbonfluorosilicone binder with a filler of pure silver, silver-plated copper, silver-plated aluminum, silverplated nickel. silver-plated glass, nickel-plated graphite, nickelplated aluminum or unplated graph-



ite particles. The development of these composites is the result of decades of research and testing, both in the laboratory and in the field. Our proprietary filler powder technology allows us to carefully control the composition, size, and morphology of the conductive particles. Their precise, uniform dispersion within the resinous binders produces materials with stable and consistent electrical and physical properties.

Parker Chomerics' conductive elastomers feature excellent resistance to compression set over a wide temperature range, resulting in years of continuous service. In addition to EMI shielding, these materials can provide an environmental or pressure seal if required.

For those materials containing silver, both packaging and storage conditions should be similar to those for other silver-containing components, such as relays or switches. They should be stored in sheet plastic, such as polyester or polyethylene, and kept away from sulfur-containing materials, such as sulfur-cured neoprene, cardboard, etc. To remove dirt, clean the elastomer with water or alcohol containing mild soap (do not use aromatic or chlorinated solvents). Shelf life of these conductive elastomers without the presence of pressure sensitive adhesive (PSA) is indefinite. Shelf life of the PSA is 12 months from date of manufacture. Refer to page 30 for Applications detailed guidance on PSA systems.

Tables 6 and 7 outline the properties and specification limits of Parker Chomerics' conductive elastomers. These materials are produced in a virtually unlimited variety of molded, die-cut and extruded shapes and sizes. Our Applications Engineering Department is very accessible, and ready to assist with material selection and gasket design. We welcome your inquiry.



MATERIAL SELECTION

The Parker Chomerics array of conductive elastomers offers true flexibility in selecting the appropriate material for a specific application on the basis of cost and level of attenuation required. Price varies directly with shielding performance.

For some military/aerospace applications, users of conductive elastomer gaskets consider specifying materials that meet MIL-DTL-83528 where appropriate but note that newer materials may not yet be included in that specification, e.g., nickel-plated aluminum filled elastomers. To avoid the risk of system EMI or environmental seal failure, any change in conductive elastomer seal supplier (including MIL-DTL-83528 QPL suppliers) should be preceded by thorough system qualification testing.

UL 94 V-0 RATED MATERIALS

Chomerics introduced the first conductive elastomer gasket material with a UL 94 V-0 rating.

Since that time, Chomerics now has a selection of UL 94 V-0 rated gasket materials including CHO-SEAL 6370, 6371, 1273, S6305 and 1310.

CHO-SEAL gasket materials are rated at UL 94 V-0 down to a thickness of 0.013 Inch (0.33 mm). Actual thickness for each certified material, and specific conditions of use can be found in UL File #OCDT2.E140244 under Insulating Devices and Materials – Components. CHO-SEAL materials certified by UL for use in Canada can be found in UL File OCDT8.E140244. For UL Certification files, please visit <u>www.ul.com</u>.

Conductive Elastomer Applications

In general, certain types of Parker's conductive elastomers are specified more often for military/aerospace applications or for commercial applications. However, there is a considerable overlap, and our Applications Engineering department will be pleased to assist you with your product selection.

ELASTOMER PRODUCT OFFERING

Military and Commercial Products

CHO-SEAL 6502 6503 - Fluorosilicone 1298 – Fluorosilicone 1285 1287 – Fluorosilicone 1215 1217 – Fluorosilicone S6305 6370 - Extruded only 6371 - Molded only 6308 - Extruded Only 6330 - Molded Only L6303 - Fluorosilicone 1350 1310 – Molded Only 1273 1270 - Molded Only

Specialty Products

CHO-SEAL 1224 - Molded Only 1221 - Fluorosilicone, Molded Only S6600 - Molded Only 1401 1239 - Molded Only 1212 - Molded Only 6435 - Molded Only 6307 - Molded Only 6452 - Extruded Only 6460 - EPDM , Molded Only V6433 - Molded Only

Refer to tables 6 and 7 for specific material properties and material guidelines.



Gasket Selection

In the early 1960s, Chomerics invented CHO-SEAL[®] 1215, an electrically conductive elastomeric gasket specifically designed to address progressive requirements within the Electromagnetic Interference and Electromagnetic Compatibility (EMI/EMC) marketplace. This revolutionary gasket material, consisting of silver plated copper particles dispersed within a silicone resin system provided a gasket capable of offering both electromagnetic shielding and a degree of environmental protection. . In the early 1980s Chomerics changed the market with the development of CHO-SEAL 1285, a silver plated aluminum filled silicone material which provided improved environmental protection with increased corrosion resistance. In the early 90's, Chomerics released CHO-SEAL 1298, a passivated silver plated aluminum fluorosilicone which again, further advance conductive elastomer technology in the area of environmental protection. Now, with the recent release of the nickel aluminum particle filled series of conductive elastomers. Chomerics has once again revolutionized the conductive elastomer gasket market with the development of CHO-SEAL 6502 and 6503 nickel-aluminum filled conductive elastomers.

The CHO-SEAL nickel-plated aluminum (Ni/Al) filled materials have been proven to simultaneously provide the best corrosion resistance (per CHO-TM101), and the highest degree of shielding effectiveness (Per CHO-TP09/IEEE STD 299) after long term aging tests of any EMI shielding elastomer gasket material. Ni/Al particles have also proven to have a lower transfer impedance (Per CHO-TM-TP10/ SAE ARP 1705) than conductive elastomers comprised of other fillers. Chomerics new material types designated as CHO-SEAL 6502 and CHO-SEAL 6503 are Silicone and Fluorosilicone elastomers respectively.

The combination of nickel and aluminum within the filler are inherently stable and have the best galvanic compatibility with chem filmed aluminum flanges which results in optimum durability and



stability. Nickel-plated aluminum particle filled elastomers provide the lowest amount of flange pitting due to galvanic corrosion. CHO-SEAL Ni/Al materials reduce flange pitting on all chromate treated flanges as compared to Ag/Al filled materials by 20 to 50%.

That being said, silver-bearing elastomers can still be a viable solution. A common misconception is that all silver-bearingconductive elastomers behave galvanically as silver. Experiments designed to show the galvanic effects of silver-filled elastomer gaskets on aluminum flanges have shown them to be far less corrosion than predicted. Silver-plated-aluminum filled elastomers exhibit the least traces of galvanic corrosion. (See Table 1).

Tables of galvanic potential do not accurately predict the corrosivity of metal-filled conductive elastomers because of the composite nature of these materials. Also, these tables do not measure directly two important aspects of conductive elastomer "corrosion resistance": 1) the corrosion of the mating metal flange and 2) the retention of conductivity by the elastomer after exposure to a corrosive environment which is necessary for EMI shielding and grounding. Instead of using a table of galvanic potentials, the corrosion caused by different conductive elastomers was determined directly by

measuring the weight loss of a T6061-T6 grade aluminum coupon in contact with the conductive elastomer (after exposure to a salt fog environment)

The electrical stability of the elastomer was determined by measuring its volume resistivity per CEPS-0002 before and after exposure. This galvanic corrosion tests were performed in accordance with Chomerics Test Method CHO-TM101.

Table 1: Corrosion Potentials for Metals and Gasket Materials

Corrosion Potentials of Various Metals and

EMI Gasket Materials (in 5% NaCl at 21°C, after 15 minutes immersion)						
Material	E _{corr} vs. SCE* (Millivolts)					
Pure Silver	-25					
Silver-filled elastomer	-50					
Monel mesh	-125					
Silver-plated-copper filled elastomer	-190					
Silver-plated-aluminum filled elastomer	-200					
Copper	-244					
Nickel	-250					
Tin-plated Beryllium-copper	-440					
Tin-plated copper-clad steel mesh	-440					
Aluminum* (1100)	-730					
Silver-plated-aluminum filled elastomer (die-cut edge)	-740					
*Standard Calamel Electrode. Aluminum Alloys approximately –700 to –840 mV vs. SCE in 3% NaCl. Mansfield, F. and Kenkel, J.V., "Laboratory Studies of Galvanic Corrosion of						

From the owner was seen in 3% wast, maintient, P. and Kenkel, J.V., "Laboratory Studies of Galvanic Corrosion of Aluminum Alloys," Galvanic and Pitting Corrosion – Field and Lab Studies, ASTM STP 576, 1976, pp. 20-47.

Table 2a: <u>168 Hour</u> T	Table 2a: 168 Hour Typical Elastomers-Galvanic Compatibility Exposure to Salt Spray / Salt Fog							
	Filler							
Substrate	Nickel-Plated Aluminum*	Passivated Silver-Plated Aluminum	Silver-Plated Aluminum	Nickel-Plated Graphite	Silver-Plated Copper			
Aluminum: 6061-T6 Conversion Coated Type I, Class 3 Finish (Hexavalent)	Excellent	Excellent	Excellent / Good	Fair	Poor			
Aluminum: 6061-T6 Conversion Coated Type II, Class 3 Finish (Trivalent)	Excellent	Excellent	Good	Fair	Poor			
Aluminum: 6061-T6 Unplated	No Data Good Fair		Fair / Poor	Not Recommended				
Stainless Steel: 304SS, 316SS	Excellent	Excellent	Excellent	Excellent	No Data			
Electroless Nickel .002" thick	Good	Good	Good	Poor	No Data			
Magnesium	Not Recommended	Not Recommended	Not Recommended	Not Recommended	Not Recommended			
Table 2b: <u>504 Hour</u> T	ypical Elastome	rs-Galvanic Con	npatibility Expo	sure to Salt Spra	y / Salt Fog			
Aluminum: 6061-T6 Conversion Coated Type I, Class 3 Finish (Hexavalent)	Excellent	Good	Fair	Poor	Not Recommended			
Aluminum: 6061-T6 Conversion Coated Type II, Class 3 Finish (Trivalent)	Good	Good	Fair	Poor	Not Recommended			

The reader should take note that this evaluation was set up to create a harsh exposure evaluation in a corrosive environment – NOT – an evaluation to maximize shielding effectiveness. Following recommended EMI gasket design guidelines for corrosive environments will produce significantly greater shielding effectiveness test results. See section on Design Guides for Corrosion Control above.

Inclusion of test data for all materials within this catalog is not practical, nor necessary to support this conclusion. The shielding effectiveness curves shown herein are a composite of results taken over several months of testing on a variety of gasket materials, flange treatments and environmental exposure conditions. This information, and further specifics on the test data/methods can be found in the Test Reports found online at www.Parker. com/Chomerics in Tech Info, under Test Reports.

Choosing the right EMI conductive gasket requires knowledge of both electrical and mechanical requirements. Shear forces, environmental effects, compression set, method of application and pricing are just some of the factors influencing choice of gasket which is best for a particular application. Materials must be both cost-effective as well as ensuring equipment and system compliance with Military and Commercial EMI/EMC test requirements and environmental test requirements. In order to help ensure a successful equipment and/or system test cycle why not start by designing in the best gasket available to help get you there -Chomerics CHO-SEAL 6502/6503.

Fluid Resistance

Table 3 below illustrate the change in physical properties of CHO-SEAL S6305 (nickel-graphite filled silicone) after exposure to a variety of common household fluids. Table 4 lists a qualitative assement of temperature and harsh fluid resistance by unfilled elastomer type. It's important to note that these are typical properties of an unfilled elastomer. In all cases, the customer is encouraged to evaluate specific CHO-SEAL materials to the requirements demanded by the application.

Table 3: Gasket Materials Eposure to Common Fluids.

Exposure of CHO-SEAL® S6305 to Common Household Fluids Tensile/Elongation in accordance with ASTM D412								
Exposure Conditi 22°C/50% RH	ons: 70 hours @	Pre-Exposure	Pre-Exposure	% Change				
ClearVue®	Tensile [psi]	200	178	-11%				
Clear vue-	Elongation [%]	289	317	10%				
Formula 409®	Tensile [psi]	200	197	-2%				
Formula 407-	Elongation [%]	289	219	-24%				
Windex®	Tensile [psi]	200	202	1%				
windex	Elongation [%]	289	166	-43%				
	Tensile [psi]	203	207	2%				
Carpet Cleaner	Elongation [%]	414	443	7%				
Coffee	Tensile [psi]	203	211	4%				
Coffee	Elongation [%]	414	439	6%				
Q. J.	Tensile [psi]	203	199	-2%				
Cola	Elongation [%]	414	433	5%				
	Tensile [psi]	203	207	2%				
Hairspray	Elongation [%]	414	326	-21%				
Tire Cleaner	Tensile [psi]	203	175	-14%				
The Cleaner	Elongation [%]	414	418	1%				
	Tensile [psi]	203	172	-15%				
Vinyl Protectant	Elongation [%]	414	433	5%				
To a Michael	Tensile [psi]	203	199	-2%				
Tap Water	Elongation [%]	414	439	6%				
Windshield	Tensile [psi]	203	207	2%				
Washer Solvent	Elongation [%]	414	418	1%				

Table 4: Gasket Material Exposure to Temperature and Harsh Fluids.

Туріса	Typical Elastomer Fluid Resistance						
Exposure/Fluid	l	Elastomer Choice					
Exposure/Fluid	Silicone	Fluorosilicons	EPDM				
High Temp	Excellent	Good	Fair				
Low Temp	Excellent	Excellent	Excellent				
ASTM 1 Oil	Fair/Good	Good	Poor				
Hydraulic Fluids (Phosphate Ester)	Poor	Poor	Good				
Hydrocarbon Fuels	Poor	Good	Poor				
Ozone, Weather	Good	Good	Good				
STB (NBC Decontamination Fluid)	Poor	Poor Fair/Good					
Dilute Acids	Fair	Good	Good				



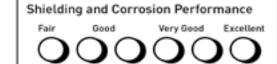


Table 5a: Quick Refe	Table 5a: Quick Reference Guide for Selecting Conductive Elastomers - Typical Commercial and Military Applications (M) = Molded only, (E) = Extruded only							
Material	Filler	Binder	Shielding	Corrosion (on Aluminum)	MIL-DTL-83528			
CHO-SEAL 6502	Nickel-Aluminum	Silicone	00000	00000				
CHO-SEAL 6503	Nickel-Aluminum	Fluorosilicone	00000	00000				
CHO-SEAL 1298	Silver-Aluminum	Fluorosilicone	000	0000	Type D			
CHO-SEAL 1285	Silver-Aluminum	Silicone	0000	000	Туре В			
CHO-SEAL 1287	Silver-Aluminum	Fluorosilicone	000	000	Type D			
CHO-SEAL 1215	Silver-Copper	Silicone	00000	0	Туре А			
CHO-SEAL 1217	Silver-Copper	Fluorosilicone	00000	0	Туре С			
CHO-SEAL S6305	Nickel-Graphite	Silicone	000	00				
CHO-SEAL 6370	Nickel-Graphite	Silicone	00	00				
CHO-SEAL 6371	Nickel-Graphite	Silicone	00	00				
CHO-SEAL 6308	Nickel-Graphite	Silicone	000	00				
CHO-SEAL 6330 ^(M)	Nickel-Graphite	Silicone	0	00				
CHO-SEAL L6303	Nickel-Graphite	Fluorosilicone	000	00				
CHO-SEAL 1350	Silver-Glass	Silicone	0000	0	Type M*			
CHO-SEAL 1310 [M]	Silver-Glass	Silicone	000	0				
CHO-SEAL 1273	Silver-Copper	Silicone	0000	Ο				
CHO-SEAL 1270 [M]	Silver-Copper	Silicone	0	0				

* Molded version of 1350 meets Mil-DTL-83528 type M specifications. Extruded version of 1350 meets Mil-DTL-83528 type M specifications except elongation (60/260).

Table 5b	Table 5b: Quick Reference Guide for Selecting Conductive Elastomers - Specialty Elastomers (M) = Molded only, (E) = Extruded only							
Material	Filler	Binder	Shielding	Corrosion (on Aluminum)	MIL-DTL-83528			
CHO-SEAL 1224 [M]	Silver	Silicone	000000	О	Туре Е			
CHO-SEAL 1221 (M)	Silver	Fluorosilicone	000000	0	Type F			
CHO-SEAL 1401	Silver	Silicone	0000	0				
CHO-SEAL 1239 [M]	Silver-Copper	Silicone/Cu Mesh	0000	0	Type G			
CHO-SEAL 1212 [M]	Silver-Copper	Silicone	00000	0	Туре К			
CHO-SEAL 6435 (M)	Silver-Nickel	EPDM	000	000				
CHO-SEAL 6307 [M]	Nickel-Graphite	EPDM	00	000				
CHO-SEAL 6452 (E)	Nickel-Graphite	EPDM	000	0000				
CHO-SEAL 6460 (M)	Nickel-Aluminum	EPDM	0000	00000				
CHO-SEAL V6433 ^(M)	Silver-Nickel	Fluoro/Fluorocarbon	000	000				
CHO-SEAL S6600 ^(M)	Carbon	Silicone	0	0				





Elastomer Filler Legend **Corrosion Resistant on Aluminum**

			Table & M	aterial Guidelin	es - Military and	Commercial			
			Test Procedure (Type of Test)	CHO-SEAL 6502	CHO-SEAL 6503	CHO-SEAL 1298	CHO-SEAL 1285	CHO-SEAL 1287	CHO-SEAL 1215
	Molde	ed (M) or Extruded (E)		M/E	M/E	M/E	M/E	M/E	M/E
	Condu	uctive Filler		Ni/Al	Ni/Al	Passivated Ag/Al	Ag/Al	Ag/Al	Ag/Cu
	Elasto	mer Binder		Silicone	Fluorosilicone	Fluorosilicone	Silicone	Fluorosilicone	Silicone
	Type (Ref. MIL-DTL-83528)			Not Applicable	Not Applicable	Type D	Туре В	Type D	Туре А
_		ne Resistivity, ohm-cm, max., as ied without pressure	CEPS-0002 ^c (Q/C)	0.150	0.250	Not Applicable	Not Applicable	Not Applicable	Not Applicable
Physical		ive adhesive	MIL-DTL-83528 (Q/C)	Not Applicable	Not Applicable	0.012	0.008	0.012	0.004
	Hardn	ess, Shore A	ASTM D2240 (Q/C)	68 ±10	72 ±10	70 ±7	65 ±7	70 ±7	65 ±7
	Specif	fic Gravity	ASTM D792 (Q/C)	1.85 ± 0.25	2.05 ± 0.25	2.00 ± 0.25	2.00 ± 0.25	2.00 ± 0.25	3.50 ±0.45
		e Strength, psi (MPa), min.	ASTM D412 (Q/C)	150 (1.03)	150 (1.03)	180 (1.24)	200 (1.38)	180 (1.24)	200 (1.38)
	Elonga	ation, % min. or % min./max.	ASTM D412 (Q/C)	100 min	50 min	60/260	100/300	60/260	100/300
		trength, lb/in. (kN/m), min.	ASTM D624 (Q)	40 (7.00)	35 (6.13)	35 (6.13)	30 (5.25)	35 (6.13)	40 (7.00) / 25 (4.38)
	70 hrs	ression Set, at 100°C, % max. ^(A)	ASTM D395, Method B (Q)	30	30	30	32	30	32
al	Low Temperature Flex TR10, °C, min.		ASTM D1329 (Q)	-55	-55	-55	-65	-55	-65
Thermal	Maximum Continuous Use Temperature, °C ^(B)			125	125	160/200	160/200	160/200	125
<u> </u>	Thermal Conductivity, W/m-K (Typical) 300 psi (2.07 MPa)		ASTM D5470	1.0	0.9	1.2	2.2	Not Tested	2.1
		ding Effectiveness, dB, min. ^(F)	Method 1:	Method 2	Method 2	Method 2	Method 2	Method 2	Method 2
) kHz (H Field)	CHO-TP08 ^c (Q)	Not Tested	Not Tested	55	60	55	70
) MHz (E Field)	Method 2:	127	127	110	115	110	120
) MHz (E Field)	MIL-DTL-83528	115	117	100	110	100	120
		Hz (Plane Wave)	Para. 4.5.12 (Q)	116	116	95	105	95	120
	100	GHz (Plane Wave)	Method 3:	127	127	90	100	90	120
le	40 0	GHz (Plane Wave)	CHO-TP09 ^c (Q)	Not 7	ested	75	Not Tested	75	90
Electrical		Heat Aging	CEPS-0002°(Q)	0.200 (H)	0.250 ^(H)	Not Applicable	Not Applicable	Not Applicable	Not Applicable
	Electrical Stability, ohm-cm, max.		MIL-DTL-83528 Para. 4.5.15 (Q/C)	Not Applicable	Not Applicable	0.015	0.010	0.015	0.010
	ical Sta	Resistance During Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	Not Applicable	Not Applicable	0.015	0.012	0.015	0.004
	Electr ohn	Resistance After Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	Not Applicable	Not Applicable	0.012	0.008	0.012	0.008
		Post Tensile Set Volume Resistivity	MIL-DTL-83528 Para. 4.5.9 (Q/C)	Not Applicable	Not Applicable	0.015	0.015	0.015	0.008
Regulatory		urvivability, r in. perimeter	MIL-DTL-83528 Para. 4.5.16 (Q)	>0.9	>0.9	>0.9	>0.9	>0.9	>0.9
gula	RoHS	Compliant		Yes	Yes	Yes	Yes	Yes	Yes
Reg	UL 94 Flammability Rating		UL 94	Not Tested	Not Tested	Not Tested	Not Tested	Not Tested	Not Tested

Note A: Compression set is expressed as a percentage of deflection per ASTM D395 Method B, at 25% deflection. To determine percent recovery, subtract 0.25 of the stated compression set value from 100%. For example, in the case of 30% compression set, recovery is 92.5%.

Note B: Where two values are shown, the first represents max. operating temp. for conformance to MIL-DTL-83528 (which requires Group A life testing at 1.25 times max. operating temp.) and the sec-ond value represents the practical limit for ex posure up to 1000 hrs. (compressed between flanges 7-10%). Single values conform to both definitions.

Note C: Copies of CEPS-0002, CHO-TP08 and CHO-TP09 are available from Chomerics. Contact Applications Engineering. Note D: Heat aging condition: 100°C for 48 hrs. Note E: Heat aging condition: 150°C for 48 hrs.

Note F: It may not be inferred that the same level of shielding effectiveness provided by a gasket ma-terial tested in the fixture per MIL-DTL-83528 Para. 4.5.12 would be provided in an actual equipment flange, since many mechanical factors of the flange design (tolerances, stiffness, fastener location and size, etc.) could lower or enhance shielding effectiveness. This procedure provides data applicable only to the test fixture design of MIL-DTL-83528, but which is useful for making comparisons between different gasket materials. The 40 GHz test data for all materials uses TP08 test method. **Note G:** Heat aging condition: 200 °C for 48 hours

Note H: Heat aging condition: 125 °C for 1000 hours

continued on next page...

ENGINEERING YOUR SUCCESS.

7



Silicone

Fluorocarbon/ EPDM

Fluorosilicone

Elastomer Filler Legend

Corrosion Resistant on Aluminum

continuedTable 6: Material Guidelines - Military and Commercial - <i>continued</i>								
		Test Procedure (Type of Test)	CHO-SEAL 1217	CHO-SEAL S6305	CHO-SEAL 6370	CHO-SEAL 6371	CHO-SEAL 6308	
Molded	(M) or Extruded (E)		M/E	M/E	E	М	E	
Conduc	tive Filler		Ag/Cu	Ni/C	Ni/C	Ni/C	Ni/C	
Elastom	ner Binder		Fluorosilicone	Silicone	Silicone	Silicone	Silicone	
Type (R	ef. MIL-DTL-83528)		Туре С	Not Applicable	Not Applicable	Not Applicable	Not Applicable	
	Resistivity, ohm-cm, max., as d without pressure	CEPS-0002° (Q/C)	Not Applicable	0.100	0.100	0.100	0.100	
	e adhesive	MIL-DTL-83528 (Q/C)	0.010	Not Applicable	Not Applicable	Not Applicable	Not Applicable	
Hardne	ss, Shore A	ASTM D2240 (Q/C)	75 ±7	65 ±10	60 ±10	65 ±10	65 ±10	
Specific	Gravity	ASTM D792 (Q/C)	4.00 ± 0.50	2.00 ± 0.25	2.10 ± 0.25	2.00 ± 0.25	2.00 ± 0.25	
Tensile	Strength, psi (MPa), min.	ASTM D412 (Q/C)	180 (1.24)	200 (1.38)	150 (1.03)	150 (1.03)	200 (1.38)	
Elongat	ion, % min. or % min./max.	ASTM D412 (Q/C)	100/300	100	100	100	75	
Tear Str	ength, lb/in. (kN/m), min.	ASTM D624 (Q)	35 (6.13)	50 (8.75)	35 (6.13)	Not Tested	40 (7.00)	
	ession Set, t 100°C, % max. ^(A)	ASTM D395, Method B (Q)	35	30	40	40	30	
°C, min.	nperature Flex TR10,	ASTM D1329 (Q)	-55	-45	-45	-40	-60	
	um Continuous Use ature, °C ^(B)		125	150	150	150	150	
Therma	l Conductivity, (Typical) 300 psi (2.07 MPa)	ASTM D5470	Not Tested	0.8	0.9	1.1	Not Tested	
	ng Effectiveness, dB, min. (F)	Method 1:	Method 2	Method 1	Method 1	Method 1	Method 1	
200 k	(Hz (H Field)	CHO-TP08 ^c (Q)	70	Not Tested	Not Tested	Not Tested	Not Tested	
100 N	MHz (E Field)	Method 2:	120	100	100	100	100	
500 N	MHz (E Field)	MIL-DTL-83528	120	100	100	100	100	
2 GH:	z (Plane Wave)	Para. 4.5.12 (Q)	115	100	95	80	100	
10 GI	Hz (Plane Wave)	Method 3:	110	100	95	80	100	
च 40 GI	Hz (Plane Wave)	CHO-TP09° (Q)	Not Tested	75	Not Tested	Not Tested	Not Tested	
	Heat Aging	CEPS-0002° (Q)	Not Applicable	0.250°	0.250 ^(e)	0.250 ^(e)	0.250°	
ability, nax.		MIL-DTL-83528 Para. 4.5.15 (Q/C)	0.015	Not Applicable	Not Applicable	Not Applicable	Not Applicable	
Electrical Stability, ohm-cm, max.	Resistance During Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	0.010	Not Applicable	Not Applicable	Not Applicable	Not Applicable	
Electr ohn	Resistance After Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	0.015	Not Applicable	Not Applicable	Not Applicable	Not Applicable	
	Post Tensile Set Volume Resistivity	MIL-DTL-83528 Para. 4.5.9 (Q/C)	0.015	Not Applicable	Not Applicable	Not Applicable	Not Applicable	
EMP Su kA per i	rvivability, n. perimeter	MIL-DTL-83528 Para. 4.5.16 (Q)	>0.9	Not Applicable	Not Applicable	Not Applicable	Not Applicable	
kA per i RoHS Co	ompliant		Yes	Yes	Yes	Yes	Yes	
UL 94 Flammability Rating		UL 94	Not Tested	V-0	V-0	V-0	Not Tested	

Note A: Compression set is expressed as a percentage of deflection per ASTM D395 Method B, at 25% deflection. To determine percent recovery, subtract 0.25 of the stated compression set value from 100%. For example, in the case of 30% compression set, recovery is 92.5%.

Note B: Where two values are shown, the first represents max. operating temp. for conformance to MIL-DTL-83528 (which requires Group A life testing at 1.25 times max. operating temp.) and the second value represents the practical limit for ex posure up to 1000 hrs. [compressed between flanges 7-10%]. Single values conform to both definitions.

Note C: Copies of CEPS-0002, CHO-TP08 and CHO-TP09 are available from Chomerics. Contact Applications Engineering.

Note D: Heat aging condition: 100°C for 48 hrs. Note E: Heat aging condition: 150°C for 48 hrs.

Note F: It may not be inferred that the same level of shielding effectiveness provided by a gasket material tested in the fixture per MIL-DTL-83528 Para. 4.5.12 would be provided in an actual equipment flange, since many mechanical factors of the flange design [tolerances, stiffness, fastener location and size, etc.] could lower or enhance shielding effectiveness. This procedure provides data applicable only to the test fixture design of MIL-DTL-83528, but which is useful for making comparisons between different gasket materials. The 40 GHz test data for all materials uses TP08 test method.

Note G: Heat aging condition: 200 °C for 48 hours

Note H: Heat aging condition: 125 °C for 1000 hours





8

Elastomer Binder Legend

Fluorosilicone







Elastomer Filler Legend

Corrosion Resistant on Aluminum

Type of Textuded (E) Type of Textuded (E) M M/E M/E M M/E M/E M M/E M/E M M/E M/E M M/E		contin	uedTable 6: Materia	l Guidelines - Mil	itary and Commer	cial - <i>continued</i>		
Conductive Filler NI/C NI/C Ag/Glass Ag/Glass Ag/Class Eastomer Binder Siltcone Fluorestilcone Siltcone Siltcone <t< th=""><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th>CHO-SEAL 1273</th></t<>								CHO-SEAL 1273
Elastomer Binder Silicone Fluorosilicone Silicone Silicone <td>Molde</td> <td>d (M) or Extruded (E)</td> <td></td> <td>М</td> <td>M/E</td> <td>M/E ^[J]</td> <td>М</td> <td>M/E</td>	Molde	d (M) or Extruded (E)		М	M/E	M/E ^[J]	М	M/E
Type (Ref. MIL-DTL-83528) Not Applicable Not Applicable Type M ^{III} Not Applicable Hardness, Shore A ASTM D2240 (Q/C) 40 ± 7 65 ±10 65 ±7 70 ±10 55 ±8 Specific Gravity ASTM D122 (Q/C) 170 ± 0.25 1.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.20 ± 0.25 ± 0.20 ± 0.20 ± 0.25 ± 0.20 ± 0.20 ± 0.25 ± 0.20 ± 0.20 ± 0.25 ± 0.20 ± 0.20 ± 0.25 ± 0.25 ± 0.20 ± 0.25 ± 0.20 ± 0.25 ± 0.20 ± 0.25 ± 0.25 ± 0.25 ± 0.20	Condu	ictive Filler		Ni/C	Ni/C	Ag/Glass	Ag/Glass	Ag/Cu
Iype (Het, MIL-DIL-8352B) Applicable Applicable Iype M ^{/-} Applicable <	Elastor	mer Binder		Silicone	Fluorosilicone	Silicone	Silicone	Silicone
Volume Resistivity, ohm-cm, max, as sensitive adhesive CEPS-0012*[01/c] 0.200 Applicable 0.000 Applicable 0.004 Not sensitive adhesive MIL-DTL-33528 Not Not Applicable 0.006 Applicable	Type (F	Ref. MIL-DTL-83528)				Type M ^[J]		Not Applicable
sensitive adhesive MIL-DIL-83328 (J/C) Not Applicable Applicable Not Applicable Applicable Not Applicable Not Applicable Not Applicable Not Applicable Hardness, Shore A ASTM D2240 (g/C) 40 ± 7 65 ± 10 65 ± 7 70 ± 10 65 ± 8.2 Specific Gravity ASTM D2240 (g/C) 1.70 ± 0.25 2.20 ± 0.25 1.80 ± 0.25 3.72 3.70 ± 0.25 3.72 3.70 ± 0.25 3.72 3.70 ± 0.25 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72 3.72			CEPS-0002 ^c (Q/C)	0.250	0.100		0.010	0.004
Specific Gravity ASTM D792 [0/C] 1.70 ± 0.25 2.20 ± 0.25 1.90 ± 0.25 1.80 ± 0.25 3.70 ± 0.25 Tensile Strength, psi (MPa), min. ASTM D412 [0/C] 120 [0.83] 105 [1.03] 200 [1.38] 200 [1.38] 175 [1.21] Elongation, % min.or % min.max. ASTM D421 [0/C] 75 60 100/300 100 75 Ters Strength, Ib/in. (RVm), min. ASTM D524 (0] Not Tested 35 [6.13] 30 [5.25] Not Tested Not Tested Compression Set, To hrs at 100°C, % max. (A) ASTM D524 (0] Not Tested 35 [6.13] 30 [5.25] Not Tested Not Tested Low Temperature Flex RT10, "C, min. ASTM D1329 (0] -40 -45 -55 -40 -65 Maximum Continuous Use Temperature Flex RT10, "C, min." ASTM D5470 0.6 0.8 1.2 Not Tested Not						0.006		Not Applicable
Tensile Strength, psi (MPa), min. ASTM D412 [Q/C] 120 (0.83) 150 (1.03) 200 (1.38) 200 (1.38) 175 (1.21) Elongation, % min. or % min./max. ASTM D424 [Q/C] 75 60 100/300 100 75 Tear Strength, [b/in. (kN/m), min. ASTM D524 [Q] Not Tested 35 (6.13) 30 (5.25) Not Tested Not Tested Compression Set, 70 hrs at 100°C, % max. % ASTM D1329 [Q] -40 -45 -55 -40 -65 Temperature Flex TR10, °C, min. ASTM D1329 [Q] -40 -45 -55 -40 -65 Thermal Conductivity, W/m K (Typical) 300 psi (2.07 MPa) ASTM D5470 0.6 0.8 1.2 Not Tested Not Tested Shielding Effectiveness, dB, min. ^(f) Method 1: CH0-TP08*[Q] Not Tested	Hardne	ess, Shore A	ASTM D2240 (Q/C)	40 ±7	65 ±10	65 ±7	70 ±10	65 ±8
Elongation, % min. or % min./max. ASTM D412 (Q/C) 75 60 100/300 100 75 Tear Strength, Ib/n. (kN/m), min. ASTM D624 (Q) Not Tested 35 (6.13) 30 (5.25) Not Tested Not Tested Compression Set, Ior Dore, % max. M Method B (Q) 25 25 30 35 32 Low Temperature Flex TR10, °C, min. ASTM D1329 (Q) -40 -45 -55 -40 -65 Maximum Continuous Use Temperature, °C (%) ASTM D5470 0.6 0.8 1.2 Not Tested Not T	Specifi	c Gravity	ASTM D792 (Q/C)	1.70 ± 0.25	2.20 ± 0.25	1.90 ± 0.25	1.80 ± 0.25	3.70 ± 0.25
Tear Strength, Ib/in. (kN/m), min. ASTM D624 (Q) Not Tested 35 (6.13) 30 (5.25) Not Tested Not Tested Compression Set, Ohrs at 100°C, % max. (th) ASTM D395, Method B (Q) 25 25 30 35 32 Low Temperature Flex TR10, °C, min. ASTM D1329 (Q) -40 -45 -55 -40 -65 Maximum Continuous Use Temperature, °C (th) 150 150 160 160 125 Thermal Conductivity, W/m-K (Typical) 300 psi (2.07 MPa) ASTM D5470 0.6 0.8 1.2 Not Tested Not Tested Shielding Effectiveness, dB, min. (the d1) Method 1: CH0-TP08°(Q) Method 2 Method 1 Method 1 Method 1 Method 1 30 GHz (Flad) MiL-DTL-83528 75 100 114 100 100 10 GHz (Plane Wave) Para. 4.5.12 (Q) 70 100 114 90 100 10 GHz (Plane Wave) MiL-DTL-83528 Not Not Not Applicable Not Tested Not Tested Not Tested Not Tested Not Te	Tensile	e Strength, psi (MPa), min.	ASTM D412 (Q/C)	120 (0.83)	150 (1.03)	200 (1.38)	200 (1.38)	175 (1.21)
Compression Set, 70 hrs at 100°C, % max. ^(h) ASTM D395, Method B (0) 25 25 30 35 32 Low Temperature Flex TR10, C, min. ASTM D1329 (0) -40 -45 -55 -40 -65 Maximum Continuous Use Temperature, ¹ C ^(m) ASTM D5470 0.6 0.8 1.2 Not Tested Not Test	Elonga	ation, % min. or % min./max.	ASTM D412 (Q/C)	75	60	100/300	100	75
70 hrs at 100°C, % max. ⁽ⁱ⁾ Method B (Q) 23 23 30 33 32 Low Temperature Flex TR10, °C, min. ASTM D1329 (Q) -40 -45 -55 -40 -65 Maximum Continuous Use Temperature, °C ® 150 150 160 160 125 Thermal Conductivity, Wrm-K (Tprical) 300 psi (2.07 MPa) ASTM D5470 0.6 0.8 1.2 Not Tested Not Tested Shielding Effectiveness, dB, min. ^(P) Method 1: CH0-TP08° (Q) Method 2: Mit-OTL-83528 Method 3 Method 1 Method 1 Method 1 200 kHz (H Field) Method 2: Mit-OTL-83528 75 100 114 100 100 30 GHz (Plane Wave) Method 3: CH0-TP09° (Q) 70 100 114 00 0.010 40 GHz (Plane Wave) Mit-DTL-83528 Not Para. 4.5.15 (U/C) Not Tested Not Tested Not Tested Not Tested Not Applicable Applicable for group Mit-DTL-83528 Not Para. 4.5.13 (U/C) Not Applicable Applicable Applicable Applicable<	Tear St	rength, lb/in. (kN/m), min.	ASTM D624 (Q)	Not Tested	35 (6.13)	30 (5.25)	Not Tested	Not Tested
*C, min. ASTM D1327 (d) 40 35 40 53 Maximum Continuous Use Temperature, °C ^(B) 150 150 160 160 125 Thermal Conductivity, W/m-K (Typical) 300 psi (2.07 MPa) ASTM D5470 0.6 0.8 1.2 Not Tested Not Tested Shielding Effectiveness, dB, min. ^(P) Method 1: CH0-TP08 ⁽ [0] Method 2 Method 1 Method 2 Method 1			· · ·	25	25	30	35	32
Temperature, °C (**)150150160160123Thermal Conductivity, W/m-K (Typical) 300 psi (2.07 MPa)ASTM D54700.60.81.2Not TestedNot TestedShielding Effectiveness, dB, min. (*) 200 HHz (H Field)Method 1: CH0-TP08° (Q)Method 3Method 1Method 2Method 1Method 1200 HHz (H Field)CH0-TP08° (Q)Not TestedNot TestedNot TestedNot TestedNot Tested100 MHz (E Field)Method 2: MIL-DTL-83528751001141001002 GHz (Plane Wave)Method 3: CH0-TP09° (Q)701001169010010 GHz (Plane Wave)Method 3: CH0-TP09° (Q)Not TestedNot TestedNot TestedNot TestedNot Tested40 GHz (Plane Wave)Method 3: CH0-TP09° (Q)CEPS-0002° (Q) $0.250^{(e)}$ Not ApplicableNot ApplicableNot ApplicableNot TestedNot TestedNot Tested40 GHz (Plane Wave)MIL-DTL-83528 Para. 4.5.15 (Q/C)Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot Applicable40 GHz (Plane Wave)MIL-DTL-83528 Para. 4.5.13 (Q)Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot Applicable40 GHz (Plane Wave)MIL-DTL-83528 Para. 4.5.13 (Q)Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot Applicable	°C. min	•	ASTM D1329 (Q)	-40	-45	-55	-40	-65
W/m-K (Typical) 300 psi (2.07 MPa)A S1M D54/U0.60.81.2Not lestedNot lestedShielding Effectiveness, dB, min. (*)Method 1: CH0-TP08° (0)Method 1: CH0-TP08° (0)Method 3Method 1Method 1Method 1200 kHz (H Field)CH0-TP08° (0)Not TestedNot Tested50Not TestedNot Tested100 MHz (E Field)Method 2: MIL-DTL-83528751001141001002 GHz (Plane Wave)Para. 4.5.12 (0)701001149010040 GHz (Plane Wave)Method 3: CH0-TP09° (0)Not TestedNot TestedNot TestedNot TestedNot Tested40 GHz (Plane Wave)CEPS-0002° (0)Not TestedNot TestedNot TestedNot TestedNot TestedNot Tested40 GHz (Plane Wave)CEPS-0002° (0)0.250 ^(e) 0.250 ^e Not ApplicableNot0.0100.01040 GHz (Plane Wave)CEPS-0002° (0)0.250 ^(e) 0.250 ^e Not ApplicableNot ApplicableNot ApplicableNot Applicable0.0100.01040 GHz (Plane Wave)MIL-DTL-83528 Para. 4.5.13 (0)Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot Applicable40 GHz (Plane Wave)MIL-DTL-83528 Para. 4.5.13 (0)Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableApplicable40 GHz (Plane Wave)MIL-DTL-83528 Para. 4.5.				150	150	160	160	125
200 kHz (H Field) CHO-TP08° (Q) Not Tested S0 Not Tested Not T	Therm W/m-K	((Typical) 300 psi (2.07 MPa)		0.6	0.8	1.2	Not Tested	Not Tested
Not Ref Not rested	Shield	ing Effectiveness, dB, min. ^(F)		Method 3	Method 1	Method 2	Method 1	Method 1
500 MHz (E Field) MIL-DTL-83528 Para. 4.5.12 (Q) 75 100 114 100 100 10 GHz (Plane Wave) Para. 4.5.12 (Q) 70 100 116 90 100 40 GHz (Plane Wave) Method 3: CH0-TP09° (Q) Not Tested Not Applicable			CHO-TP08 ^c (Q)	Not Tested	Not Tested	50	Not Tested	Not Tested
500 MHz (E Field) MIL-DTL-83528 Para. 4.5.12 (Q) 75 100 114 100 100 10 GHz (Plane Wave) Para. 4.5.12 (Q) 70 100 116 90 100 40 GHz (Plane Wave) Method 3: CH0-TP09° (Q) 70 100 124 80 100 40 GHz (Plane Wave) Method 3: CH0-TP09° (Q) Not Tested 0.010	100	MHz (E Field)	Method 2:	75	100		100	100
10 GHz (Plane Wave)Method 3: CHO-TP09° (Q)701001248010040 GHz (Plane Wave)Method 3: CHO-TP09° (Q)Not TestedNot Tested<	500	MHz (E Field)		75	100	114	100	100
40 GHz (Plane Wave)Method 3: CHO-TP09° (Q)Not TestedNot TestedNot TestedNot TestedNot TestedNot TestedVigrey by diversionHeat AgingCEPS-0002° (Q)0.250°0.250°Not ApplicableNot Applicable0.0100.010MIL-DTL-83528 Para. 4.5.15 (Q/C)Not ApplicableNot ApplicableNot Applicable0.015Not ApplicableNot ApplicableResistance During Vibration Para. 4.5.13 (Q)MIL-DTL-83528 Para. 4.5.13 (Q)Not ApplicableNot Applicable0.009Not ApplicableNot ApplicablePost Tensile Set Volume ResistivityMIL-DTL-83528 Para. 4.5.9 (Q/C)Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableEMP Survivability, KA per in. perimeterMIL-DTL-83528 Para. 4.5.16 (Q)Not ApplicableNot ApplicableNot ApplicableNot ApplicableROHS CompliantYes YesYes YesYes YesYes YesYes Yes	2 GF	Hz (Plane Wave)	Para. 4.5.12 (Q)		100	116	90	100
40 GHz (Plane Wave)CH0-TP09° (Q)Not TestedNot TestedNot TestedNot TestedNot TestedNot TestedImage: Problem of the probl	10 G	GHz (Plane Wave)		70	100	124	80	100
Vigged Figsed EHeat AgingCEPS-0002°(Q)0.250°0.250°Applicable0.0100.0100.010Heat AgingMIL-DTL-83528 Para. 4.5.15 (Q/C)Not ApplicableNot Applicable0.015Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableResistance During VibrationMIL-DTL-83528 Para. 4.5.13 (Q)Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicablePost Tensile Set Volume ResistivityMIL-DTL-83528 Para. 4.5.9 (Q/C)Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableEMP Survivability, KA per in. perimeterMIL-DTL-83528 Para. 4.5.16 (Q)Not ApplicableNot ApplicableNot ApplicableNot ApplicableNot ApplicableRoHS CompliantYesYesYesYesYes	40 G	GHz (Plane Wave)		Not Tested	Not Tested	Not Tested	Not Tested	Not Tested
And the second		Heat Aging		0.250 ^(e)	0.250°		0.010	0.010
Image: Constraint of the set of the se	ability, max.			Applicable	Applicable	0.015	Applicable	Applicable
Image: Constraint of the set of the se	'ical Sta	Resistance During Vibration	Para. 4.5.13 (Q)			0.009		Not Applicable
ResistivityPara. 4.5.9 (Q/C)ApplicableApplicableUUUYApplicableApplicableEMP Survivability, kA per in. perimeterMIL-DTL-83528 Para. 4.5.16 (Q)NotNot>0.9NotNotROHS CompliantYesYesYesYesYesYes	Electi	Resistance After Vibration	Para. 4.5.13 (Q)	Applicable		0.006	Applicable	Not Applicable
kA per in. perimeter Para. 4.5.16 (Q) Applicable Applicable >U.9 Applicable Applicable RoHS Compliant Yes Yes Yes Yes Yes		Resistivity	Para. 4.5.9 (Q/C)	Applicable	Applicable	0.009	Applicable	Applicable
	kA per	in. perimeter		Applicable	Applicable		Applicable	Not Applicable
UL 94 Flammability Rating UL 94 Not Tested Not Tested V-0 V-0	RoHSC	Compliant		Yes	Yes	Yes	Yes	Yes
	2 UL 94 F	Flammability Rating	UL 94	Not Tested	Not Tested	Not Tested	V-0	V-0

Note A: Compression set is expressed as a percentage of deflection per ASTM D395 Method B, at 25% deflection. To determine percent recovery, subtract 0.25 of the stated compression set value from 100%. For example, in the case of 30% compression set, recovery is 92.5%.

Note B: Where two values are shown, the first represents max. operating temp. for conformance to MIL-DTL-83528 (which requires Group A life testing at 1.25 times max. operating temp.) and the second value represents the practical limit for ex posure up to 1000 hrs. (compressed between flanges 7-10%). Single values conform to both definitions.

Note C: Copies of CEPS-0002, CHO-TP08 and CHO-TP09 are available from Chomerics. Contact Applications Engineering.

Note D: Heat aging condition: 100°C for 48 hrs.

Note E: Heat aging condition: 150°C for 48 hrs.

Note F: It may not be inferred that the same level of shielding effectiveness provided by a gasket material tested in the fixture per MIL-DTL-83528 Para. 4.5.12 would be provided in an actual equipment flange, since many mechanical factors of the flange design (tolerances, stiffness,

fastener location and size, etc.) could lower or enhance shielding effectiveness. This procedure provides data applicable only to the test fixture design of MIL-DTL-83528, but which is useful for making comparisons between different gasket materials. The 40 GHz test data for all materials uses TP08 test method. Note G: Heat aging condition: 200 °C for 48 hours

Note H: Heat aging condition: 125 °C for 1000 hours

Note J: Molded version of 1350 meets Mil-DTL-83528 type M specifications. Extruded version of 1350 meets Mil-DTL-83528 type M specifications except elongation (60/260).

continued on next page...

ENGINEERING YOUR SUCCESS.

Elastomer Binder Legend Silicone Fluorosilicone



Fluorocarbon/ Fluorosilicone

EPDM

Elastomer Filler Legend

Corrosion Resistant on Aluminum

		continue	dTable 6: Material Gui			1		
			Test Procedure (Type of Test)	CHO-SEAL 1270	CHO-SEAL 1224	CHO-SEAL 1221	CHO-SEAL 1401	CHO-SEAL 1239
	Molde	ed (M) or Extruded (E)		М	М	М	M/E	М
	Condu	uctive Filler		Ag/Cu	Ag	Ag	Ag	Ag/Cu
	Elastomer Binder			Silicone	Silicone	Fluorosilicone	Silicone	Silicone & Expanded Cu Foil
	Type (Ref. MIL-DTL-83528)			Not Applicable	Type E	Type F	Not Applicable	Туре G
cal		ne Resistivity, ohm-cm, max., as ied without pressure	CEPS-0002° (Q/C)	0.050	Not Applicable	Not Applicable	Not Applicable	Not Applicable
Physical		ive adhesive	MIL-DTL-83528 (Q/C)	Not Applicable	0.002	0.002	0.010	0.007
	Hardn	ness, Shore A	ASTM D2240 (Q/C)	40 ±7	65 ±7	75 ±7	45 ±5	80 ±7
	Specif	fic Gravity	ASTM D792 (Q/C)	2.90 ± 0.25	3.50 ±0.45	4.00 ±0.50	1.60 ± 0.25	4.75 ± 0.75
	Tensil	e Strength, psi (MPa), min.	ASTM D412 (Q/C)	80 (0.55)	300 (2.07)	250 (1.72)	200 (1.38)	600 (4.14)
		ation, % min. or % min./max.	ASTM D412 (Q/C)	75	200/500	100/300	75	20
	Tear S	trength, lb/in. (kN/m), min.	ASTM D624 (Q)	Not Tested	50 (8.75)	40 (7.00)	20 (3.50)	70 (12.25)
		pression Set, s at 100°C, % max. ^(A)	ASTM D395, Method B (Q)	30	45	60	35	Not Tested
al	Low Temperature Flex TR10, °C, min.		ASTM D1329 (Q)	-60	-65	-65	-55	Not Tested
Thermal	Maximum Continuous Use Temperature, °C ^(B)			125	160/200	160/200	160/200	125
	Thermal Conductivity, W/m-K (Typical) 300 psi (2.07 MPa)		ASTM D5470	0.8	2.8	Not Tested	0.9	1.9
	Shield	ding Effectiveness, dB, min. ^(F)	Method 1:	Method 3	Method 2	Method 2	Method 2	Method 2
	200) kHz (H Field)	CHO-TP08 ^c (Q)	Not Tested	70	70	60	70
	100) MHz (E Field)	Method 2:	80	120	120	100	110
	500) MHz (E Field)	MIL-DTL-83528	80	120	120	100	110
	2 G	Hz (Plane Wave)	Para. 4.5.12 (Q)	70	120	120	90	110
	10 (GHz (Plane Wave)	Method 3:	70	120	120	80	110
cal	40 (GHz (Plane Wave)	CHO-TP09 ^c (Q)	Not Tested	Not Tested	Not Tested	Not Tested	Not Tested
Electrical		Heat Aging	CEPS-0002° (Q)	0.100 ^e	Not Applicable	Not Applicable	Not Applicable	Not Applicable
	ical Stability, 1-cm, max.		MIL-DTL-83528 Para. 4.5.15 (Q/C)	Not Applicable	0.010	0.010	0.015	0.010
	ical Sta	Resistance During Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	Not Applicable	0.010	0.010	0.015	0.007
	Electric ohm-	Resistance After Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	Not Applicable	0.002	0.002	0.010	Not Applicable
		Post Tensile Set Volume Resistivity	MIL-DTL-83528 Para. 4.5.9 (Q/C)	Not Applicable	0.010	0.010	0.020	Not Applicable
Regulatory		urvivability, r in. perimeter	MIL-DTL-83528 Para. 4.5.16 (Q)	Not Applicable	>0.9	>0.9	>0.9	>0.9
gula	RoHS	Compliant		Yes	Yes	Yes	Yes	Yes
Red	UL 94	Flammability Rating	UL 94	Not Tested	Not Tested	Not Tested	Not Tested	Not Tested

* Molded only

Note A: Compression set is expressed as a percentage of deflection per ASTM D395 Method B, at 25% deflection. To determine percent recovery, subtract 0.25 of the stated compression set value from 100%. For example, in the case of 30% compression set, recovery is 92.5%.

Note B: Where two values are shown, the first represents max. operating temp. for conformance to MIL-DTL-83528 (which requires Group A life testing at 1.25 times max. operating temp.) and the second value represents the practical limit for ex posure up to 1000 hrs. (compressed

between flanges 7-10%). Single values conform to both definitions

Note C: Copies of CEPS-0002, CHO-TP08 and CHO-TP09 are available from Chomerics. Contact Applications Engineering. Note D: Heat aging condition: 100°C for 48 hrs.

Note E: Heat aging condition: 150°C for 48 hrs.

Note F: It may not be inferred that the same level of shielding effectiveness provided by a gasket material tested in the fixture per MIL-DTL-83528 Para. 4.5.12 would be provided in an actual equipment flange, since many mechanical factors of the flange design (tolerances, stiffness, provides data applicable only to the test fixture design of MIL-DTL-83528, but which is useful for making comparisons between different gasket materials. The 40 GHz test data for all materials uses TP08 test method.

Note G: Heat aging condition: 200 °C for 48 hours

Note H: Heat aging condition: 125 °C for 1000 hours



continued on next page...

Elastomer Binder Legend Silicone Fluorosilicone EPDM

Fluorocarbon/ Fluorosilicone

Elastomer Filler Legend

Corrosion Resistant on Aluminum

		continued	Table 6: Material Guid	elines - Military	and Commercia	al - <i>continued</i>		
			Test Procedure (Type of Test)	CHO-SEAL 1212	CHO-SEAL 6435	CHO-SEAL 6307	CHO-SEAL 6452	CHO-SEAL 6460
	Molde	d (M) or Extruded (E)		М	м	М	E	М
	Condu	uctive Filler		Ag/Cu	Ag/Ni	Ni/C	Ni/C	Ni/Al+Ni/C
	Elasto	mer Binder		Silicone	EPDM	EPDM	EPDM	EPDM
	Type (Ref. MIL-DTL-83528)			Туре К	Not Applicable	Not Applicable	Not Applicable	Not Applicable
		e Resistivity, ohm-cm, max., as ed without pressure	CEPS-0002 ^c (Q/C)	Not Applicable	0.006	5.000	Not Applicable	Not Applicable
Physical		ive adhesive	MIL-DTL-83528 (Q/C)	0.005	Not Applicable	Not Applicable	0.500	0.600
Р	Hardn	ess, Shore A	ASTM D2240 (Q/C)	85 ±7	80 ±7	75 ±7	70 ±10	65 ±7
	Specif	ic Gravity	ASTM D792 (Q/C)	3.50 ± 0.45	3.70 ± 0.25	1.90 ± 0.25	1.95 ± 0.25	1.80 ± 0.25
	Tensile	e Strength, psi (MPa), min.	ASTM D412 (Q/C)	400 (2.76)	200 (1.38)	200 (1.38)	200 (1.38)	200 (1.38)
	Elonga	ation, % min. or % min./max.	ASTM D412 (Q/C)	100/300	200	75	200	200
	Tear St	trength, lb/in. (kN/m), min.	ASTM D624 (Q)	40 (7.00)	75 (13.13)	60 (10.51)	55 (9.63)	50 (8.75)
		ression Set, at 100°C, % max. ^(A)	ASTM D395, Method B (Q)	35	40	40	35	30
1	Low Te °C, mir	emperature Flex TR10, n.	ASTM D1329 (Q)	-45	-40	-45	-50	-50
Thermal	Maximum Continuous Use Temperature, °C ^(B)			125	100	100	100	100
F		al Conductivity, K (Typical) 300 psi (2.07 MPa)	ASTM D5470	1.8	1.8	0.6	Not Tested	Not Tested
	Shield	elding Effectiveness, dB, min. (F) Method 1:		Method 2	Method 2	Method 2	Method 3	Method 2
	200	kHz (H Field)	CHO-TP08 ^c (Q)	70	Not Tested	Not Tested	Not Tested	Not Tested
	100	100 MHz (E Field) Method 2:		120	105	95	75	110
	500	MHz (E Field)	MIL-DTL-83528	120	100	90	100	120
		Hz (Plane Wave)	Para. 4.5.12 (Q)	120	85	85	105	105
	10 0	GHz (Plane Wave)	Mathed 2	120	85	85	85	100
cal	40 0	GHz (Plane Wave)	Method 3: CHO-TP09 ^c (Q)	Not Tested	Not Tested	Not Tested	Not Tested	Not Tested
Electrical		Heat Aging	CEPS-0002° (Q)	Not Applicable	0.0125 ^[d]	10 ^d	Not Applicable	Not Applicable
	cal Stability, -cm, max.	Treat righting	MIL-DTL-83528 Para. 4.5.15 (Q/C)	0.010	Not Applicable	Not Applicable	0.350	2.500₽
	ectrical Stabilit ohm-cm, max.	Resistance During Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	0.010	Not Applicable	Not Applicable	Not Applicable	Not Applicable
	Electric	Resistance After Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	0.005	Not Applicable	Not Applicable	Not Applicable	Not Applicable
		Post Tensile Set Volume Resistivity	MIL-DTL-83528 Para. 4.5.9 (Q/C)	0.010	Not Applicable	Not Applicable	Not Applicable	Not Applicable
Regulatory		urvivability, r in. perimeter	MIL-DTL-83528 Para. 4.5.16 (Q)	>0.9	Not Applicable	Not Applicable	Not Applicable	Not Applicable
gula	RoHS	Compliant		Yes	Yes	Yes	Yes	Yes
Reg	UL 94	Flammability Rating	UL 94	Not Tested	Not Tested	Not Tested	Not Tested	Not Tested

Note A: Compression set is expressed as a percentage of deflection per ASTM D395 Method B, at 25% deflection. To determine percent recovery, subtract 0.25 of the stated compression set value from 100%. For example, in the case of 30% compression set, recovery is 92.5%.

Note B: Where two values are shown, the first represents max. operating temp. for conformance to MIL-DTL-83528 (which requires Group A life testing at 1.25 times max. operating temp.) and the second value represents the practical limit for ex posure up to 1000 hrs. (compressed between flanges 7-10%). Single values conform to both definitions

Note C: Copies of CEPS-0002, CHO-TP08 and CHO-TP09 are available from Chomerics. Contact

Applications Engineering. Note D: Heat aging condition: 100°C for 48 hrs.

Note E: Heat aging condition: 150°C for 48 hrs.

Note F: It may not be inferred that the same level of shielding effectiveness provided by a gasket material tested in the fixture per MIL-DTL-83528 Para. 4.5.12 would be provided in an actual equipment flange, since many mechanical factors of the flange design (tolerances, stiffness, fastener location and size, etc.] could lower or enhance shielding effectiveness. This procedure provides data applicable only to the test fixture design of MIL-DTL-83528, but which is useful for making comparisons between different gasket materials. The 40 GHz test data for all materials uses TP08 test method.

Note G: Heat aging condition: 200 °C for 48 hours

Note H: Heat aging condition: 125 °C for 1000 hours

continued on next page...

11

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		continuedTab	le 7: Material Guidelines - Sp	pecialty Products - <i>continued</i>	
			Test Procedure (Type of Test)	CHO-SEAL V6433	CHO-SEAL S6600
	Moldec	I (M) or Extruded (E)		М	М
	Conduc	ctive Filler		Ag/Ni	Carbon
	Elastom	ner Binder		Fluorocarbon/ Fluorosilicone	Silicone
	Type (R	ef. MIL-DTL-83528)		Not Applicable	Not Applicable
16		Resistivity, ohm-cm, max., as sup- ithout pressure	CEPS-0002° (Q/C)	Not Applicable	7
Physical	sensitiv	re adhesive	MIL-DTL-83528 (Q/C)	0.006	Not Applicable
	Hardne	ss, Shore A	ASTM D2240 (Q/C)	85 ±7	75 ±7
	<u> </u>	Gravity	ASTM D792 (Q/C)	4.80 ± 0.25	1.20 ±0.25
	Tensile	Strength, psi (MPa), min.	ASTM D412 (Q/C)	400 (2.76)	650 (4.48)
	<u> </u>	tion, % min. or % min./max.	ASTM D412 (Q/C)	50	70
		ength, lb/in. (kN/m), min.	ASTM D624 (Q)	70 (12.25)	Not Tested
	70 hrs a	ession Set, at 100°C, % max. ^(A)	ASTM D395, Method B (Q)	45	45
16	Low Ter °C, min	mperature Flex TR10,	ASTM D1329 (Q)	-25	-45
Thermal	Maximum Continuous Use Temperature, °C ^(B)			200	200
		ıl Conductivity, (Typical) 300 psi (2.07 MPa)	(Typical) 300 psi (2.07 MPa) ASTM D5470 2.1		0.6
	Shieldi	ng Effectiveness, dB, min. ^(F)	Method 1:	Method 2	Method 1
	200	kHz (H Field)	CHO-TP08 ^c (Q)	Not Tested	Not Tested
	100 /	MHz (E Field)	Method 2:	105	80
	500 I	MHz (E Field)	MIL-DTL-83528	100	80
	2 GH	z (Plane Wave)	Para. 4.5.12 (Q)	90	60
	10 G	Hz (Plane Wave)	Method 3:	90	50
Electrical	40 G	Hz (Plane Wave)	CHO-TP09 ^c (Q)	Not Tested	Not Tested
ectr			CEPS-0002° (Q)	0.008 ⁹	7 ^(E)
E	oility, ax.	Heat Aging	ohm-cm, max.	Not Applicable	Not Applicable
	al Stak cm, m	Resistance During Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	Not Applicable	Not Applicable
	Electrical Stability, ohm-cm, max.	Resistance After Vibration	MIL-DTL-83528 Para. 4.5.13 (Q)	Not Applicable	Not Applicable
		Post Tensile Set Volume Resistivity	MIL-DTL-83528 Para. 4.5.9 (Q/C)	Not Applicable	Not Applicable
	EMP Su	rvivability,	MIL-DTL-83528	Not	Not
Regulatory	kA per i	n. perimeter	Para. 4.5.16 (Q)	Applicable	Applicable
gula	RoHS C	ompliant		Yes	Yes
Reg	UL 94 F	L 94 Flammability Rating UL 94		Not tested	Not Tested

Note A: Compression set is expressed as a percentage of deflection per ASTM D395 Method B, at 25% deflection. To determine percent recovery, subtract 0.25 of the stated compression set value from 100%. For example, in the case of 30% compression set, recovery is 92.5%. Note B: Where two values are shown, the first represents max. operating temp. for conformance to MIL-DTL-83528 (which requires Group A life testing at 1.25 times max. operating

temp.) and the second value represents the practical limit for ex posure up to 1000 hrs. (com-pressed between flanges 7-10%). Single values conform to both definitions. **Note C:** Copies of CEPS-0002, CH0-TP08 and CH0-TP09 are available from Chomerics. Contact Applications Engineering. Note D: Heat aging condition: 100°C for 48 hrs. Note E: Heat aging condition: 150°C for 48 hrs.

Note F: It may not be inferred that the same level of shielding effectiveness provided by a gasket material tested in the fixture per MIL-DTL-83528 Para. 4.5.12 would be provided in an actual equipment flange, since many mechanical factors of the flange design (tolerances, stiffness, fastener location and size, etc.) could lower or enhance shielding effectiveness. This procedure provides data applicable only to the test fixture design of MIL-DTL-83528, but which is useful for making comparisons between different gasket materials. The 40 GHz test data for all materials uses TP08 test method.

Note G: Heat aging condition: 200 °C for 48 hours

Note H: Heat aging condition: 125 °C for 1000 hours



12

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